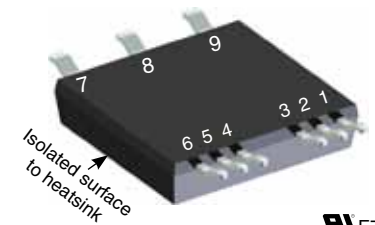
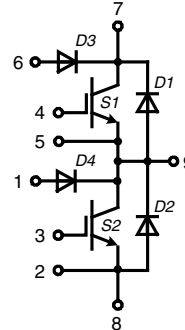


# XPT IGBT phaseleg ISOPLUS™ Surface Mount Power Device

$$\begin{aligned} I_{C25} &= 43 \text{ A} \\ V_{CES} &= 1200 \text{ V} \\ V_{CE(sat) \text{ typ}} &= 1.9 \text{ V} \end{aligned}$$



E72873

## IGBTs S1, S2

| Symbol              | Conditions                                                                                                                     | Maximum Ratings |               |
|---------------------|--------------------------------------------------------------------------------------------------------------------------------|-----------------|---------------|
| $V_{CES}$           | $T_{VJ} = 25^{\circ}\text{C to } 150^{\circ}\text{C}$                                                                          | 1200            | V             |
| $V_{GES}$           |                                                                                                                                | $\pm 20$        | V             |
| $I_{C25}$           | $T_C = 25^{\circ}\text{C}$                                                                                                     | 43              | A             |
| $I_{C80}$           | $T_C = 80^{\circ}\text{C}$                                                                                                     | 30              | A             |
| $I_{CM}$            | $V_{GE} = 15 \text{ V}; R_G = 39 \Omega; T_{VJ} = 125^{\circ}\text{C}$<br>RBSOA, clamped inductive load; $L = 100 \mu\text{H}$ | 75              | A             |
| $V_{CEK}$           |                                                                                                                                | $V_{CES}$       |               |
| $t_{SC}$<br>(SCSOA) | $V_{CE} = 900 \text{ V}; V_{GE} = \pm 15 \text{ V}; R_G = 39 \Omega; T_{VJ} = 125^{\circ}\text{C}$<br>none repetitive          | 10              | $\mu\text{s}$ |
| $P_{tot}$           | $T_C = 25^{\circ}\text{C}$                                                                                                     | 150             | W             |

## Symbol Conditions Characteristic Values

(T<sub>VJ</sub> = 25°C, unless otherwise specified)

|                |                                                                                                                                                | min. | typ.       | max. |                     |
|----------------|------------------------------------------------------------------------------------------------------------------------------------------------|------|------------|------|---------------------|
| $V_{CE(sat)}$  | $I_C = 25 \text{ A}; V_{GE} = 15 \text{ V}; T_{VJ} = 25^{\circ}\text{C}$<br>$T_{VJ} = 125^{\circ}\text{C}$                                     |      | 1.9<br>2.2 | 2.2  | V<br>V              |
| $V_{GE(th)}$   | $I_C = 1 \text{ mA}; V_{GE} = V_{CE}$                                                                                                          | 5.4  |            | 6.5  | V                   |
| $I_{CES}$      | $V_{CE} = V_{CES}; V_{GE} = 0 \text{ V}; T_{VJ} = 25^{\circ}\text{C}$<br>$T_{VJ} = 125^{\circ}\text{C}$                                        |      | 200        | 2.1  | mA<br>$\mu\text{A}$ |
| $I_{GES}$      | $V_{CE} = 0 \text{ V}; V_{GE} = \pm 20 \text{ V}$                                                                                              |      |            | 500  | nA                  |
| $t_{d(on)}$    | Inductive load; $T_{VJ} = 125^{\circ}\text{C}$<br>$V_{CE} = 600 \text{ V}; I_C = 25 \text{ A}$<br>$V_{GE} = \pm 15 \text{ V}; R_G = 39 \Omega$ |      | 70         |      | ns                  |
| $t_r$          |                                                                                                                                                |      | 40         |      | ns                  |
| $t_{d(off)}$   |                                                                                                                                                |      | 250        |      | ns                  |
| $t_f$          |                                                                                                                                                |      | 100        |      | ns                  |
| $E_{on}$       |                                                                                                                                                |      | 2.5        |      | mJ                  |
| $E_{off}$      |                                                                                                                                                |      | 3.0        |      | mJ                  |
| $E_{(rec)off}$ |                                                                                                                                                |      | tbd        |      |                     |
| $C_{ies}$      | $V_{CE} = 25 \text{ V}; V_{GE} = 0 \text{ V}; f = 1 \text{ MHz}$                                                                               |      | tbd        |      | pF                  |
| $Q_{Gon}$      | $V_{CE} = 600 \text{ V}; V_{GE} = 15 \text{ V}; I_C = 25 \text{ A}$                                                                            |      | 76         |      | nC                  |
| $R_{thJC}$     |                                                                                                                                                |      | 0.85       |      | K/W                 |
| $R_{thJH}$     | with heatsink compound (IXYS test setup)                                                                                                       |      | 0.95       | 1.3  | K/W                 |

## Features

- **XPT IGBT**
  - low saturation voltage
  - positive temperature coefficient for easy paralleling
  - fast switching
  - short tail current for optimized performance in resonant circuits
- **Sonic™ diode**
  - fast reverse recovery
  - low operating forward voltage
  - low leakage current
- **V<sub>CEsat</sub> detection diode**
  - integrated into package
  - very fast diode
- **Package**
  - isolated back surface
  - low coupling capacity between pins and heatsink
  - PCB space saving
  - enlarged creepage towards heatsink
  - application friendly pinout
  - low inductive current path
  - high reliability

## Applications

- **Phaseleg**
  - buck-boost chopper
- **Full bridge**
  - power supplies
  - induction heating
  - four quadrant DC drives
  - controlled rectifier
- **Three phase bridge**
  - AC drives
  - controlled rectifier

## Diodes D1, D2

| Symbol                                               | Conditions                                                                                                               | Maximum Ratings         |      |      |      |     |
|------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------|-------------------------|------|------|------|-----|
| I <sub>F25</sub>                                     | T <sub>C</sub> = 25°C                                                                                                    |                         |      | 40   | A    |     |
| I <sub>F80</sub>                                     | T <sub>C</sub> = 80°C                                                                                                    |                         |      | 27   | A    |     |
| Symbol                                               | Conditions                                                                                                               | Characteristic Values   |      |      |      |     |
| (T <sub>VJ</sub> = 25°C, unless otherwise specified) |                                                                                                                          |                         |      |      |      |     |
|                                                      |                                                                                                                          |                         | min. | typ. | max. |     |
| V <sub>F</sub>                                       | I <sub>F</sub> = 20 A                                                                                                    | T <sub>VJ</sub> = 25°C  |      | 1.9  | 2.4  | V   |
|                                                      |                                                                                                                          | T <sub>VJ</sub> = 125°C |      | 1.9  |      | V   |
| I <sub>RM</sub>                                      | I <sub>F</sub> = 20 A; R <sub>G</sub> = 39 Ω; T <sub>VJ</sub> = 125°C<br>V <sub>R</sub> = 600 V; V <sub>GE</sub> = -15 V |                         |      | 30   |      | A   |
| t <sub>rr</sub>                                      |                                                                                                                          |                         |      | 350  |      | ns  |
| E <sub>rec</sub>                                     |                                                                                                                          |                         |      | 0.85 |      | mJ  |
| R <sub>thJC</sub>                                    | per diode                                                                                                                |                         |      |      | 0.9  | K/W |
| R <sub>thJH</sub>                                    | with heatsink compound (IXYS test setup)                                                                                 |                         |      | 1.2  | 1.5  | K/W |

## Diodes D3, D4

| Symbol                                               | Conditions                                                                    | Maximum Ratings                               |      |      |      |    |
|------------------------------------------------------|-------------------------------------------------------------------------------|-----------------------------------------------|------|------|------|----|
| V <sub>R</sub>                                       | T <sub>C</sub> = 25°C to 150°C                                                |                                               |      |      | 1200 | V  |
| Symbol                                               | Conditions                                                                    | Characteristic Values                         |      |      |      |    |
| (T <sub>VJ</sub> = 25°C, unless otherwise specified) |                                                                               |                                               |      |      |      |    |
|                                                      |                                                                               |                                               | min. | typ. | max. |    |
| V <sub>F</sub>                                       | I <sub>F</sub> = 1 A                                                          | T <sub>VJ</sub> = 25°C                        |      | 1.7  | 2.2  | V  |
|                                                      |                                                                               | T <sub>VJ</sub> = 125°C                       |      | 1.5  |      | V  |
| I <sub>R</sub>                                       | V <sub>R</sub> = 1200 V                                                       | T <sub>VJ</sub> = 25°C                        |      |      | 2    | μA |
|                                                      |                                                                               | T <sub>VJ</sub> = 125°C                       |      | 30   |      | μA |
| I <sub>RM</sub>                                      | I <sub>F</sub> = 1 A; di <sub>F</sub> /dt = -100 A/μs; T <sub>VJ</sub> = 25°C |                                               |      | 2.3  |      | A  |
| t <sub>rr</sub>                                      |                                                                               | V <sub>R</sub> = 100 V; V <sub>GE</sub> = 0 V |      | 40   |      | ns |

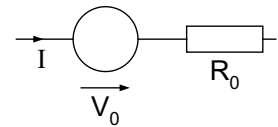
## Component

| Symbol     | Conditions                                                | Maximum Ratings       |      |            |    |
|------------|-----------------------------------------------------------|-----------------------|------|------------|----|
| $T_{VJ}$   |                                                           |                       |      | -55...+150 | °C |
| $T_{stg}$  |                                                           |                       |      | -55...+125 | °C |
| $V_{ISOL}$ | $I_{ISOL} \leq 1\text{ mA}; 50/60\text{ Hz}$              |                       |      | 2500       | V~ |
| $F_C$      | mounting force                                            |                       |      | 40 ... 130 | N  |
| Symbol     | Conditions                                                | Characteristic Values |      |            |    |
|            |                                                           | min.                  | typ. | max.       |    |
| $C_P$      | coupling capacity between shorted pins and backside metal |                       | 90   |            | pF |
| $d_S, d_A$ | pin - pin                                                 | 1.65                  |      |            | mm |
| $d_S, d_A$ | pin - backside metal                                      | 4                     |      |            | mm |
| CTI        |                                                           | 400                   |      |            |    |
| Weight     |                                                           |                       | 8    |            | g  |

| Ordering | Ordering Name        | Marking on Product | Delivering Mode | Base Qty | Ordering Code |
|----------|----------------------|--------------------|-----------------|----------|---------------|
| Standard | IXA30PG1200DHGLB-TRR | IXA30PG1200DHGLB   | Tape&Reel       | 200      | 511846        |

## Equivalent Circuits for Simulation

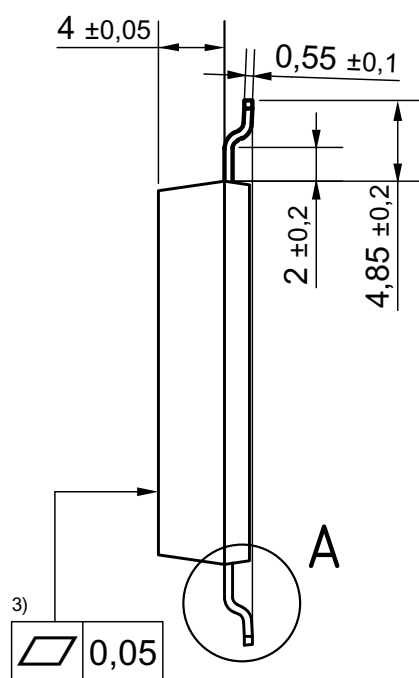
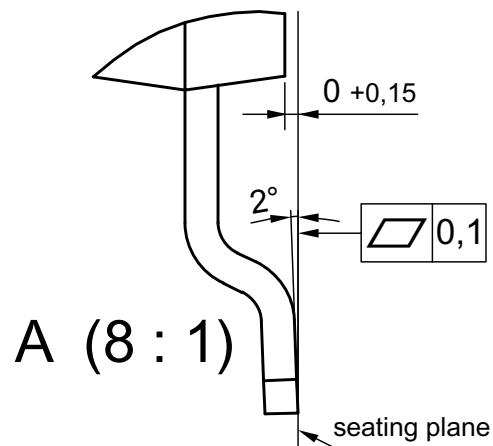
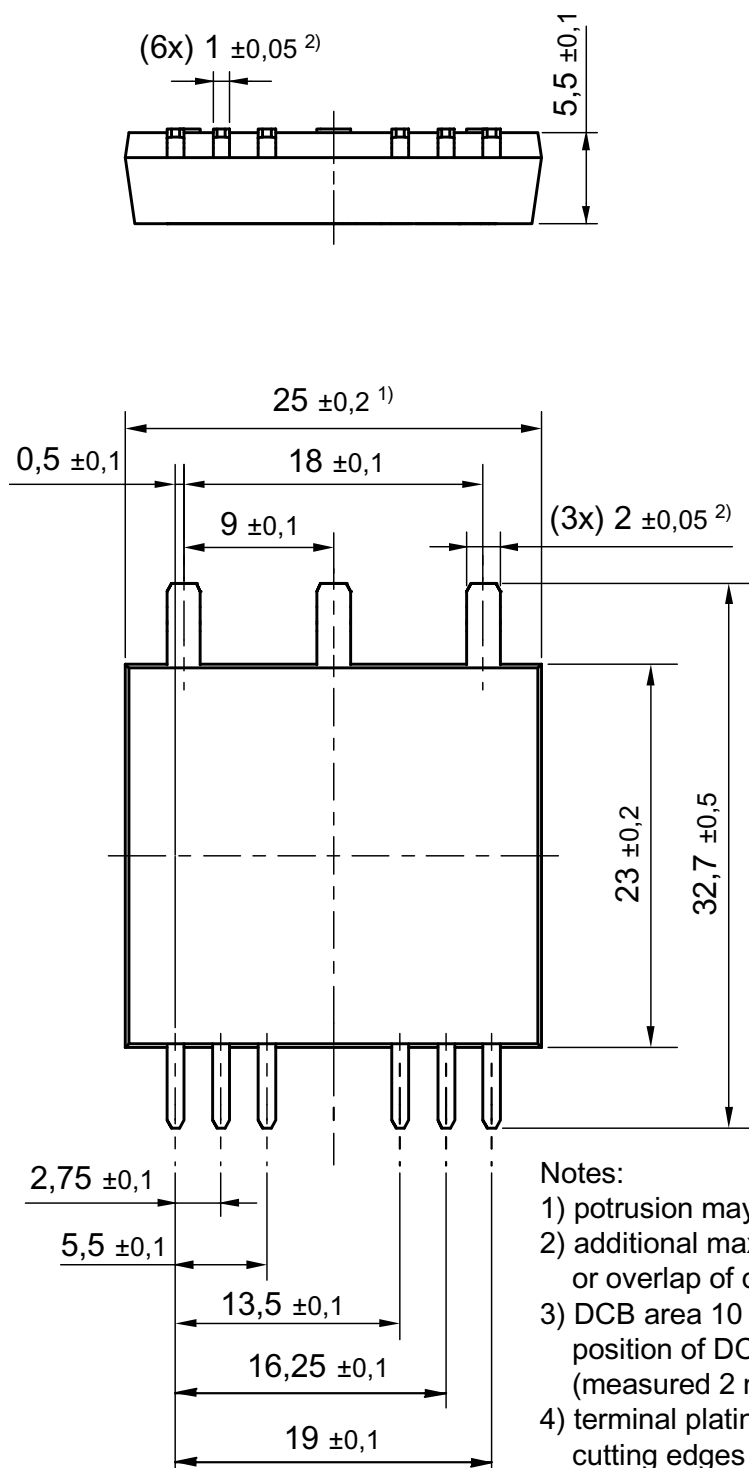
## Conduction



IGBTs (typ. at  $V_{GE} = 15\text{ V}; T_J = 125^\circ\text{C}$ )  
S1, S2  $V_0 = 1.1\text{ V}; R_0 = 60\text{ m}\Omega$

Diodes (typ. at  $T_J = 125^\circ\text{C}$ )  
D1, D2  $V_0 = 1.3\text{ V}; R_0 = 28\text{ m}\Omega$

Dimensions in mm (1 mm = 0.0394")



#### Notes:

- 1) potrusion may add 0.2 mm max. on each side
- 2) additional max. 0.05 mm per side by punching misalignment or overlap of dam bar or bending compression
- 3) DCB area 10 to 50  $\mu\text{m}$  convex;  
position of DCB area in relation to plastic rim:  $\pm 25 \mu\text{m}$   
(measured 2 mm from Cu rim)
- 4) terminal plating: 0.2 - 1  $\mu\text{m}$  Ni + 10 - 25  $\mu\text{m}$  Sn (gal v.)  
cutting edges may be partially free of plating

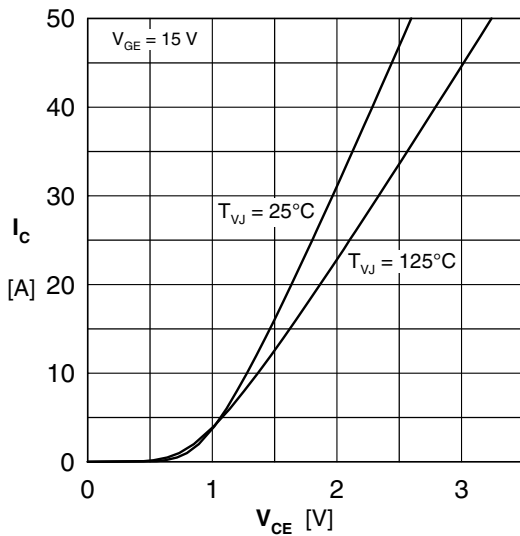


Fig. 1 Typ. output characteristics

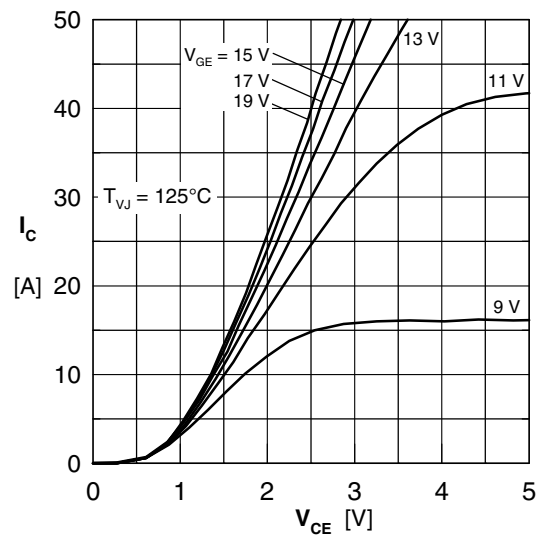


Fig. 2 Typ. output characteristics

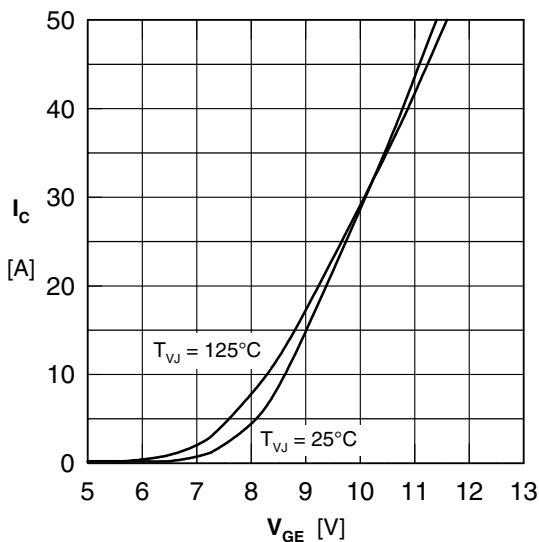


Fig. 3 Typ. transfer characteristics

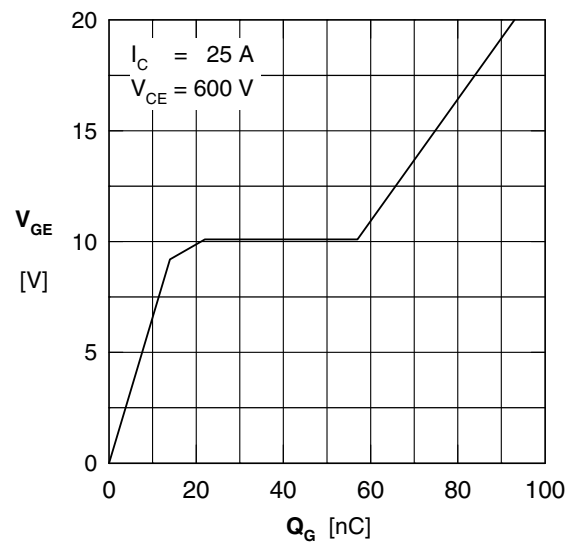


Fig. 4 Typ. turn-on gate charge

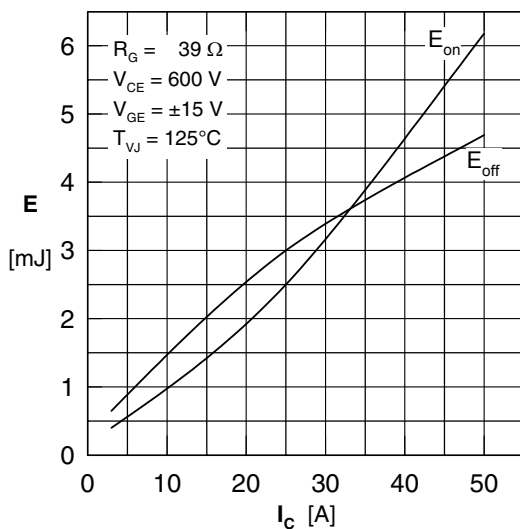


Fig. 5 Typ. switching energy vs. collector current

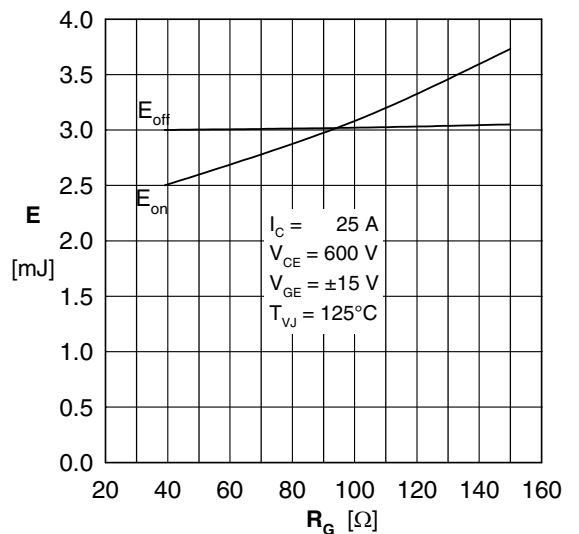
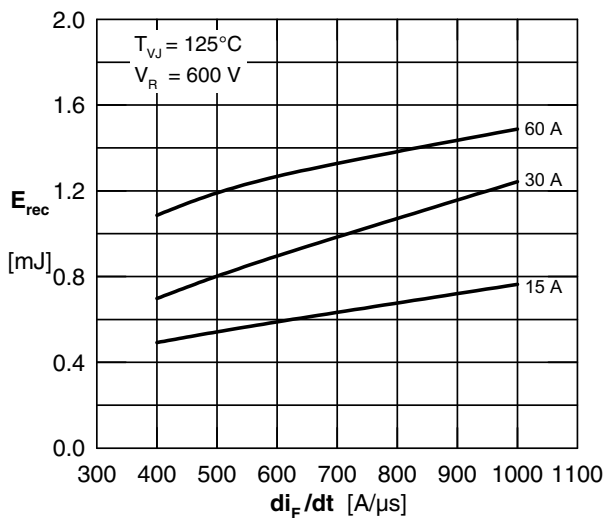
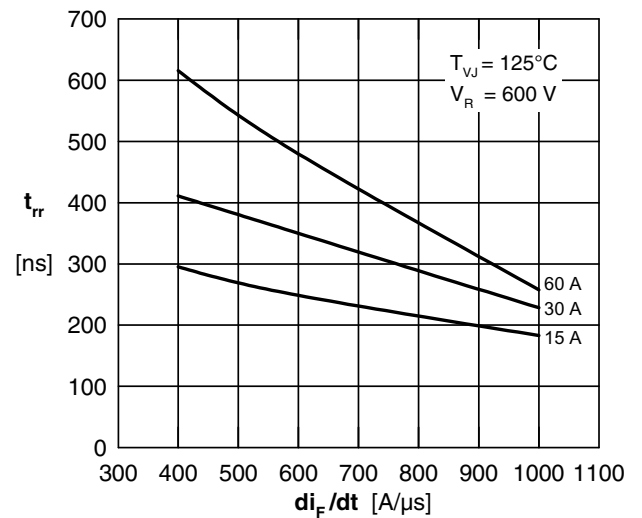
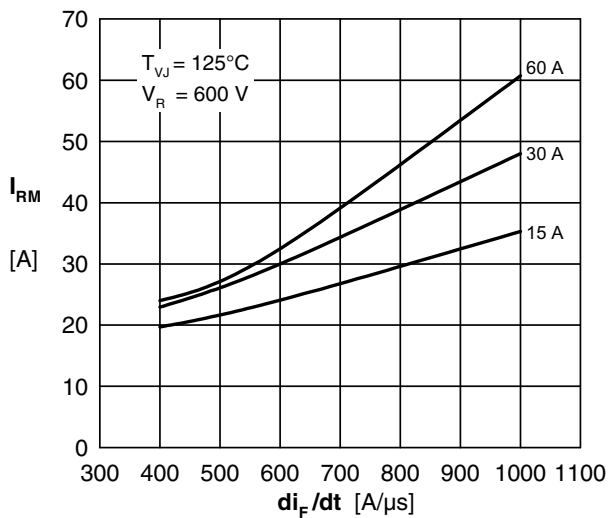
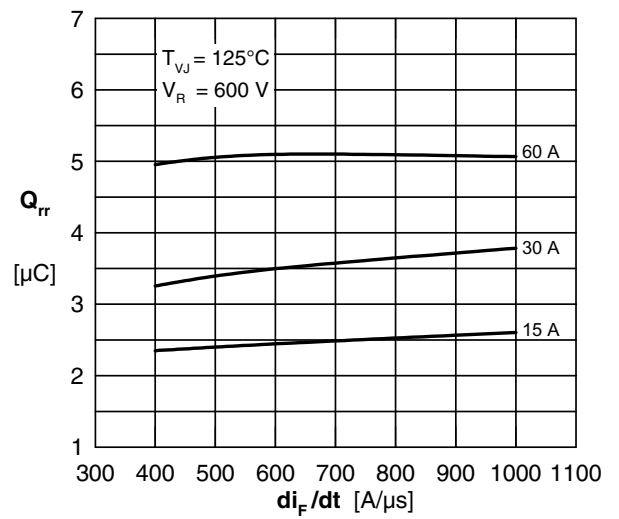
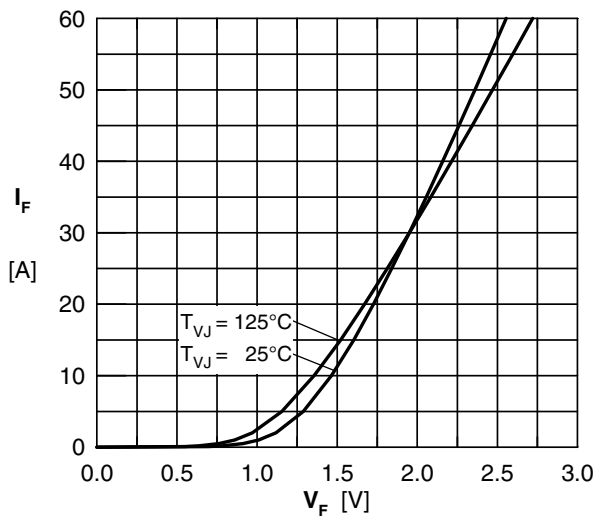


Fig. 6 Typ. switching energy vs. gate resistance





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